IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Atsushi SAKURAI et al. Conf. 1454

Application No. 10/583,942 Group 1792

Filed June 22, 2006 Examiner Joel G. Horning

METAL COMPOUND, MATERIAL FOR THIN FILM FORMATION, AND PROCESS OF FORMING THIN FILM

AMENDMENT

Assistant Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

October 13, 2009

Sir:

In response to the Official Action mailed May 12, 2009, for which the period for response has been extended <u>two</u> months, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.